

MOSFETs Silicon Carbide N-Channel MOS

TW083N65C

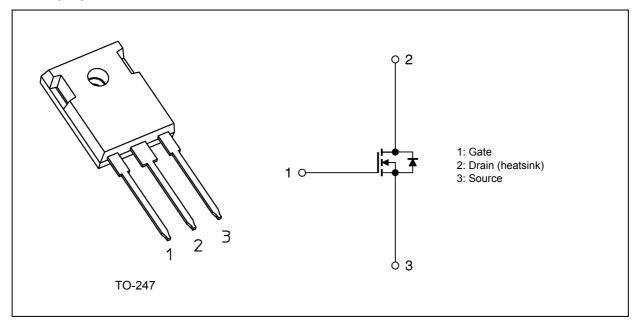
1. Applications

• Switching Voltage Regulators

2. Features

- (1) Chip design of 3rd generation (Built-in SiC schottky barrier diode)
- (2) Low diode forward voltage: $V_{DSF} = -1.35 \text{ V (typ.)}$
- (3) High voltage: $V_{DSS} = 650 \text{ V}$
- (4) Low drain-source on-resistance: $R_{DS(ON)} = 83 \text{ m}\Omega$ (typ.)
- (5) Less susceptible to malfunction due to high threshold voltage: V_{th} = 3.0 to 5.0 V (V_{DS} = 10 V, I_D = 0.6 mA)
- (6) Enhancement mode.

3. Packaging and Internal Circuit





4. Absolute Maximum Ratings (Note) (T_a = 25 °C unless otherwise specified)

	Characteristics	Symbol	Rating	Unit
Drain-source voltage		V _{DSS}	650	V
Gate-source voltage		V_{GSS}	+25/-10	
Drain current (DC)	(T _c = 25 °C)	I _D	30	Α
Drain current (DC)	(T _c = 100°C)	I _D	21]
Drain current (pulsed)	(T _c = 25 °C)	I _{DP}	66	
Drain current (pulsed)	(T _c = 100°C)	I _{DP}	52]
Power dissipation	(T _c = 25°C)	P _D	111	W
Channel temperature		T _{ch}	175	℃
Storage temperature		T _{stg}	-55 to 175]
Mounting torque		TOR	0.8	N · m

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

5. Thermal Characteristics

Characteristics	Symbol	Max	Unit
Channel-to-case thermal resistance	R _{th(ch-c)}	1.350	°C/W
Channel-to-ambient thermal resistance	R _{th(ch-a)}	50	

Note 1: Ensure that the channel temperature does not exceed 175 °C.

Note: This transistor is sensitive to electrostatic discharge and should be handled with care. It should be used for switching applications.



6. Electrical Characteristics

6.1. Static Characteristics (T_a = 25 °C unless otherwise specified)

Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage current		I _{GSS}	V _{GS} = +25/-10 V, V _{DS} = 0 V	_	_	±0.1	μА
Drain cut-off current		I _{DSS}	V _{DS} = 650 V, V _{GS} = 0 V	_	3	37	
			T _a = 150 °C, V _{DS} = 650 V, V _{GS} = 0 V	1	14	1	
Drain-source breakdown voltage		V _{(BR)DSS}	$I_D = 4$ mA, $V_{GS} = 0$ V	650	_		V
Gate threshold voltage	(Note 2)	V _{th}	V _{DS} = 10 V, I _D = 0.6 mA	3.0	_	5.0	
Drain-source on-resistance		R _{DS(ON)}	V _{GS} = 18 V, I _D = 15 A	_	83	113	mΩ
			T _a = 150 °C, V _{GS} = 18 V, I _D = 15 A		89		

Note 2: Please be sure to apply I_{GSS} (V_{GS} = 25 V) before the V_{th} test.

6.2. Dynamic Characteristics (T_a = 25 °C unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Input capacitance	C _{iss}	V _{DS} = 400 V, V _{GS} = 0 V,	_	873	_	pF
Reverse transfer capacitance	C _{rss}	f = 100 kHz	_	3.4	_	
Output capacitance	C _{oss}			110	_	
Output charge	Q _{oss}		_	72	_	nC
C _{oss} stored energy	E _{oss}		_	10	_	μJ
Gate resistance	r _g	V _{DS} = OPEN, f = 1 MHz	_	4.4	_	Ω
Switching time (rise time)	t _r	See Fig. 6.2.1	_	41	_	ns
Switching time (turn-on time)	t _{on}		_	68	_	
Switching time (fall time)	t _f]	_	28	_	
Switching time (turn-off time)	t _{off}		_	55		

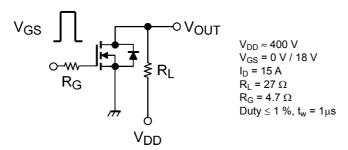


Fig. 6.2.1 Switching Time Test Circuit

6.3. Gate Charge Characteristics (T_a = 25 °C unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Total gate charge (gate-source plus gate-drain)		$V_{DD} \approx 400 \text{ V}, V_{GS} = 18 \text{ V},$ $I_{D} = 15 \text{ A}$	1	28	ı	nC
Gate-source charge 1	Q _{gs1}			14		
Gate-drain charge	Q_{gd}		_	3.9	_	



6.4. Source \cdot Drain Characteristics (T_a = 25 °C unless otherwise specified)

Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit
Reverse drain current (DC)	(Note 3)	I _{DR}	T _c = 25 °C, V _{GS} = -5 V	_	_	26	Α
			T _c = 100 °C, V _{GS} = -5 V	_	_	17	
			T _c = 25 °C, V _{GS} = 18 V	_	_	30	
			T _c = 100 °C, V _{GS} = 18 V	_	_	21	
Reverse drain current	(Note 3)	I _{DRP}	T _c = 25 °C, V _{GS} = -5 V	_	_	66	
(pulsed)			T _c = 100 °C, V _{GS} = -5 V	_	_	33	
			T _c = 25 °C, V _{GS} = 18 V	_	_	66	
			T _c = 100 °C, V _{GS} = 18 V	_	_	52	
Diode forward voltage		V _{DSF}	I _{DR} = 8 A, V _{GS} = -5 V	_	-1.35	-1.80	V
			T _a = 150 °C, I _{DR} = 8 A, V _{GS} = -5 V	_	-1.57	_	
Reverse recovery time		t _{rr}	I _{DR} = 10 A, V _{GS} = 0 V,	_	45	_	ns
Reverse recovery charge		Q _{rr}	$V_{DD} = 400 \text{ V}, -dI_{DR}/dt = 1000 \text{ A}/\mu\text{s}$	_	189	_	nC
Peak reverse recovery current		I _{rr}		1	8.4		Α

Note 3: Ensure that the channel temperature does not exceed 175 °C.

Rev.1.0



7. Marking (Note)

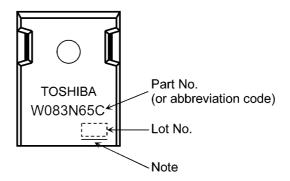


Fig. 7.1 Marking

Note: A line under a Lot No. identifies the indication of product Labels.

Not underlined: [[Pb]]/INCLUDES > MCV

Underlined: [[G]]/RoHS COMPATIBLE or [[G]]/RoHS [[Pb]]

Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of Product.

The RoHS is the Directive 2011/65/EU of the European Parliament and of the Council of 8 June 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment.



8. Characteristics Curves (Note)

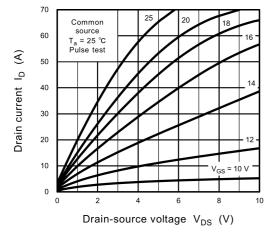


Fig. 8.1 I_D - V_{DS}

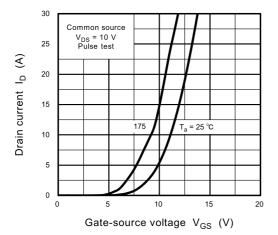


Fig. 8.3 I_D - V_{GS}

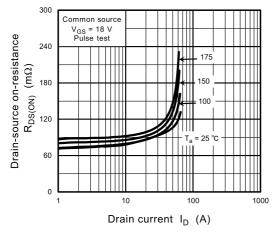


Fig. 8.5 R_{DS(ON)} - I_D

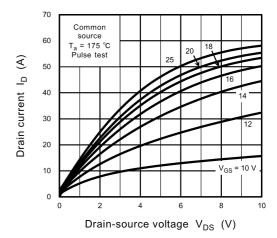


Fig. 8.2 I_D - V_{DS}

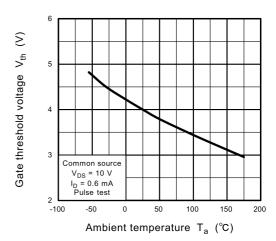


Fig. 8.4 V_{th} - T_a

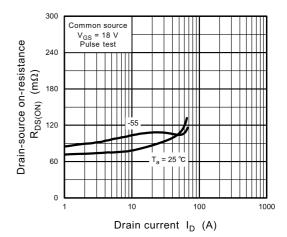


Fig. 8.6 R_{DS(ON)} - I_D



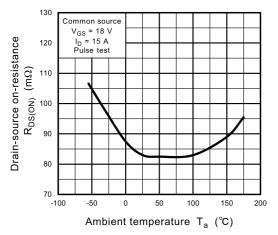


Fig. 8.7 R_{DS(ON)} - T_a

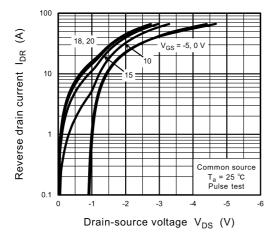


Fig. 8.9 IDR - VDS

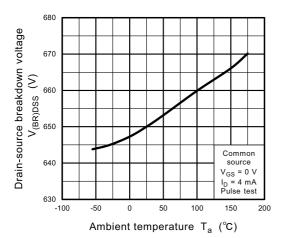


Fig. 8.11 V_{DSS} - T_a

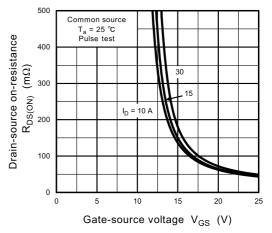


Fig. 8.8 R_{DS(ON)} - V_{GS}

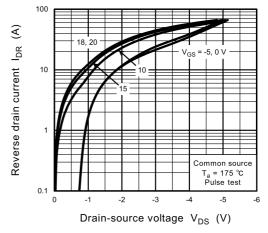


Fig. 8.10 I_{DR} - V_{DS}

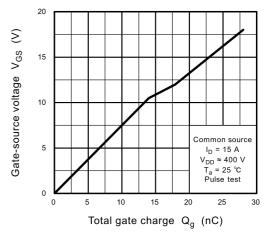
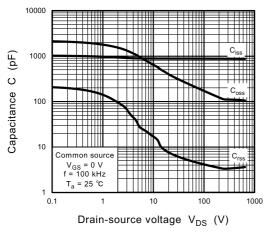


Fig. 8.12 Dynamic Input Characteristics





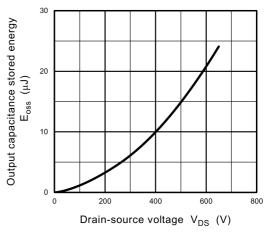


Fig. 8.13 C - V_{DS}

Fig. 8.14 E_{oss} - V_{DS}

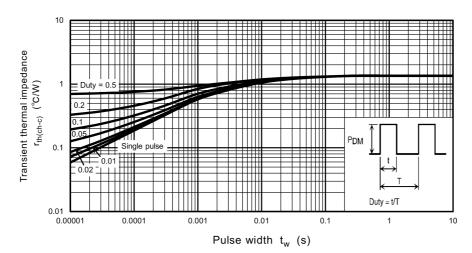
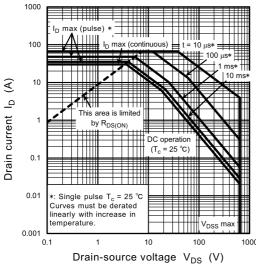


Fig. 8.15 $r_{th(ch-c)} - t_w$ (Guaranteed Maximum)



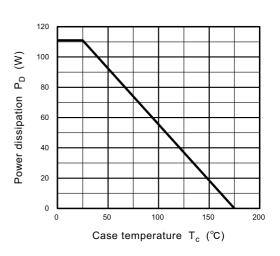


Fig. 8.16 Safe Operating Area (Guaranteed Maximum)

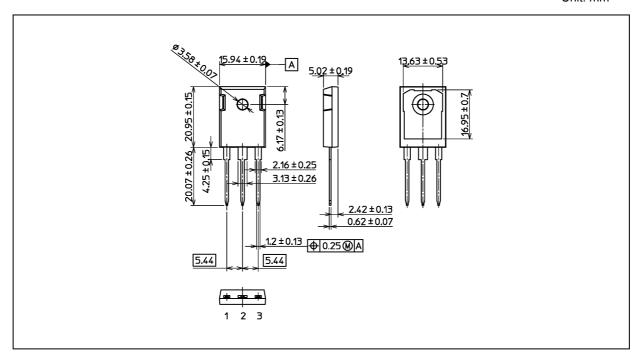
Fig. 8.17 P_D - T_c (Guaranteed Maximum)

Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



Package Dimensions

Unit: mm



Weight: 6.15 g (typ.)

Package Name(s)
TOSHIBA: 2-16L1A
Nickname: TO-247



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